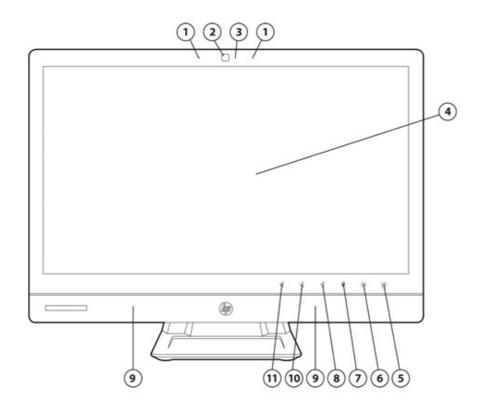
Overview

HP EliteOne 800 G1 All-in-One Business PC



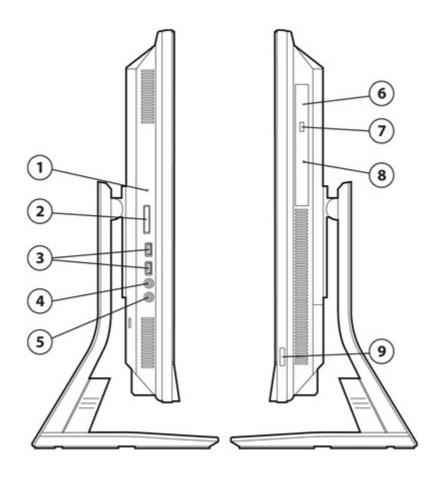
FRONT

- 1. Dual microphone array (only on models with Webcam)
- 2. 2.0 MP Webcam (optional)
- 3. Webcam Activity LED
- 4. 23-inch IPS Full HD capable screen (with or without projected capacitive touch panel option)
- 5. Increase brightness
- 6. Decrease brightness
- 7. Mute microphone
- 8. Increase volume
- 9. High performance stereo speakers
- 10. Reduce volume
- 11. Mute speaker



Overview

HP EliteOne 800 G1 All-in-One Business PC



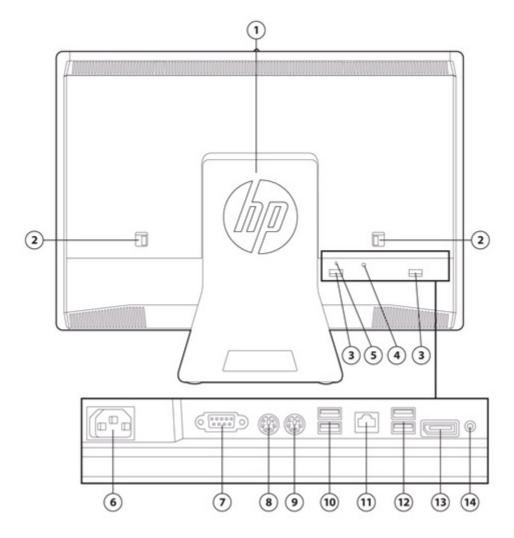
SIDE

- 1. Hard disc drive activity LED
- 2. HP SD media card reader (optional)
- 3. (2) USB 3.0 ports, including 1 fast charging port
- 4. Microphone/line in jack
- 5. Headphone/line out jack
- 6. Tray-load optical disc drive (optional)
- 7. Optical disc drive eject button
- 8. Optical disc drive activity LED
- 9. Power button



Overview

HP EliteOne 800 G1 All-in-One Business PC



REAR/PORTS (BEHIND SECURITY COVER)

- 1. Basic Stand*
- 2. Access panel latches
- 3. I/O security cover latch
- 4. Security Screw hole
- 5. Security lock slot
- 6. Power connector
- 7. Serial port

- 8. PS/2 mouse connector
- 9. PS/2 keyboard connector
- 10. (2) USB 3.0 ports
- 11. RJ-45 Gigabit Ethernet port
- 12. (2) USB 3.0 ports
- 13. DisplayPort connector
- 14. Stereo line out



^{*} Can be configured with no stand, basic stand, or height adjustable/reclining stand

Overview

At A Glance

- Windows 7 or Windows 8
- UEFI BIOS developed and engineered by HP for better security, manageability and software image stability
- Integrated All-in-One form factor
- 23-inch IPS (1920 x 1080) diagonal widescreen WLED backlit anti-glare LCD, with or without Projected Capacitive Touch Panel option
- Landscape or portrait display orientation with height adjustable stand or VESA mount
- Can be configured with no stand, basic stand, or height adjustable/reclining stand
- Intel® Q87 chipset
- Intel® 4th generation Core™ processors
- Intel® vPro™ Technology available with select processors
- Integrated Intel® HD Graphics
- Optional MXM Discrete graphics
- Integrated Intel® I217LM Gigabit Network Connection
- Optional wireless connectivity:
 - O Intel® Advanced-N 6205 WLAN Intel® 802.11 a/b/g/n
 - O Intel® Dual Band Wireless-N 7260 Intel 802.11 a/b/q/n
 - O WLAN and Bluetooth Combo Card HP 802.11 a/b/g/n and Bluetooth® 4.0
- WiDi support (with Intel® 6205 WLAN and Intel® HD Graphics)
- Optional Near Field Communication (NFC)
- Optional Integrated 2.0 MP Webcam & Dual Microphone Array
- High performance integrated stereo speakers
- DTS Studio Sound™
- Up to 16 GB of DDR3 SDRAM, dual channel memory support, two SODIMM slots
- Support for up to 3 storage drives (2 SATA, 1 mSATA) with RAID support
- Up to 500GB SATA Hard Drive, up to 160GB Solid State Drive, 500 GB Self-Encrypting Drive, 256GB Self-Encrypting Solid State Drive, and 1TB Solid State Hybrid Drive
- Optional Intel® Smart Response Technology support with 32GB mSATA SSD Flash Cache Module
- Optional slim Tray-load SuperMulti DVD Writer, DVD-ROM, or BDXL Blu-ray Writer Optical Disc Drive
- Optional SD Media Card Reader
- Serial port
- DisplayPort out
- Integrated VESA 100 x 100 mounting holes
- Lockable rear access panel with intrusion sensor
- ENERGY STAR® qualified. EPEAT® registered where applicable/supported. See www.epeat.net for registration status by country.
- CCC, CECP & SEPA Certified
- Optimized for Microsoft Lync
- TCO AiO and TCO Edge
- Low Halogen
- Arsenic Free
- Protected by HP Services, including warranties up to 5-5-5 (terms and conditions vary by country; certain restrictions and exclusions apply)



OPERATING SYSTEM

Preinstalled

Windows 8 Pro (64-bit)* Windows 8 (64-bit)*

Windows 7 Ultimate (64-bit)**

Windows 7 Professional (32-bit)**

Windows 7 Professional (64-bit)**

Windows 7 Professional (32-bit) (available through downgrade rights from Windows 8 Pro)***

Windows 7 Professional (64-bit) (available through downgrade rights from Windows 8 Pro)***

Windows 7 Home Premium (32-bit)**

Windows 7 Home Premium (64-bit)**

Windows 7 Home Basic (32-bit)**

FreeDOS 2.0

Novell SUSE Linux Enterprise Desktop 11

*Not all features are available in all editions of Windows 8. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows 8 functionality. See http://www.microsoft.com.

**Not all features are available in all editions of Windows 7. This system may require upgraded and/or separately purchased hardware to take full advantage of Windows® 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.

***This system is preinstalled with Windows 7 Pro software and also comes with a license and media for Windows 8 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

PROCESSOR

Intel® 4th Generation Core™ i7 Processors

Intel® Core™ i7-4770S

Up to 3.9 GHz Max. Turbo Frequency (3.1 GHz base frequency), 8 MB cache, 4 cores, 8 threads

Intel® HD Graphics 4600

Supports DDR3 memory up to 1600 MT/s data rate

Supports Intel® vPro Technologies and Intel's® Stable Image Platform Program (SIPP)

Intel® 4th Generation Core™ i5 Processors

Intel® Core™ i5-4670S

Up to 3.8 GHz Max. Turbo Frequency (3.1 GHz base frequency), 6 MB cache, 4 cores, 4 threads

Intel® HD Graphics 4600

Supports DDR3 memory up to 1600 MT/s data rate

Supports Intel® vPro Technologies and Intel's® Stable Image Platform Program (SIPP)



Standard Features and Configurable Components (availability may vary by country)

Intel® Core™ i5-4570S

Up to 3.6 GHz Max. Turbo Frequency (2.9 GHz base frequency), 6 MB cache, 4 cores, 4 threads Intel® HD Graphics 4600

Supports DDR3 memory up to 1600 MT/s data rate

Supports Intel® vPro Technologies and Intel's® Stable Image Platform Program (SIPP)

Intel® 4th Generation Core™ i3 Processors

Intel® Core™ i3-4340

3.6 GHz base frequency, 4 MB cache, 2 cores, 4 threads Intel® HD Graphics 4600

Supports DDR3 memory up to 1600 MT/s data rate

Intel® Core™ i3-4330

3.5 GHz base frequency, 4 MB cache, 2 cores, 4 threads Intel® HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate

Intel® Core™ i3-4130

3.4 GHz base frequency, 3 MB cache, 2 cores, 4 threads Intel® HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate

Intel® 4th Generation Pentium™ Processors

Intel® Pentium™ G3430

3.3 GHz base frequency, 3 MB cache, 2 cores, 2 threads Intel® HD Graphics

Supports DDR3 memory up to 1600 MT/s data rate

Intel® Pentium™ G3420

3.2 GHz base frequency, 3 MB cache, 2 cores, 2 threads Intel® HD Graphics

Supports DDR3 memory up to 1600 MT/s data rate

Intel® Pentium™ G3220

3.0 GHz base frequency, 3 MB cache, 2 cores, 2 threads Intel® HD Graphics Supports DDR3 memory up to 1300 MT/s data rate

CHIPSET

Intel® 8 Series (Q87) Chipset



INTEL® VPRO TECHNOLOGY CAPABLE

Intel® Core i5 with vPro and Core i7 with vPro technology is a selectable feature that is available on units configured with select processors, and a preinstalled Windows operating system. It provides advances in remote manageability, security, energy efficient performance, and wireless connectivity. Intel® Active Management Technology 9.0 (iAMT) offers an advanced set of remote management features and functionality which provides network administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 9.0 includes the following advanced management functions:

- Power Management (on, off, reset)
- Hardware Inventory (includes BIOS and firmware revisions
- Hardware Alerting
- Agent Presence
- System Defense Filters
- SOL/IDER
- Cisco NAC/SDN Support
- ME Wake-on-LAN
- DASH 1.1 compliance
- IPv6 Support
- Fast Call for Help a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection
- Remote Scheduled Maintenance pre-schedule when the PC connects to the IT or service provider console for maintenance.
 Remote PCs can get required patches, be inventoried, etc by connecting to their IT console or Service Provider when it's convenient
- Remote Alerts automatically alert IT or service provider if issues arise
- Access Monitor Provides oversight into Intel® AMT actions to support security requirements
- PC Alarm Clock
- Microsoft NAP Support
- Host Base set-up and configuration
- Management Engine (ME) firmware roll back
- Wireless AMT functionality on Desktop (WoDT)*
- Enhanced KVM resolution



^{*} Requires Intel® Advanced-N 6205 WLAN 802.11a/b/g/n PCIe Minicard Wireless Module

INTEL® STANDARD MANAGEABILITY

Includes DASH 1.0/1.1 compliance plus:

- System Defense
- Agent Presence
- SOL/IDE Redirection
- CISCO NAC/SDN support
- ME Wake on LAN
- Host Based Configuration
- ME Firmware Rollback
- IPv6 Support

DASH 1.0/1.1 compliance:

- Boot Control
- HW Inventory
- SW Inventory
- Power State Management
- HW Alerting

SMBIOS

System Management BIOS, previously known as DMI BIOS, is used to store system management information.

GRAPHICS

Integrated

Intel® HD Graphics 4600

Graphics controller Intel® Processor Graphics

DisplayPort Multi-Stream support (supports up to 2 external displays)⁴

Memory Up to 1.8GB DDR3

Supported Graphics APIs DX11.1, OpenGL 4.0, OpenCL 1.2, full 1080p Blu-Ray Disc

(H264) playback in hardware

Discrete (optional)

AMD® Radeon HD 7650A 2GB DDR3 MXM Graphics

Graphics controller AMD® Radeon HD 7650A

DisplayPort Multi-Stream support (supports up to 4 external displays at

1920x1080)4

Core clock 600MHz max Memory clock 800MHz max

Memory frame buffer 2GB, DDR3, 128-bit wide

Memory 2GB DDR3

Supported Graphics APIs DX11, OpenGL 4.1, OpenGL 1.1, full 1080p Blu-Ray Disc (H264)

playback in hardware



⁴Using the Integrated Graphics, two (2) external displays are supported via one of these methods: Using the MXM Graphics, up to four (4) external displays are supported via one of these methods:

- 1) DisplayPort multi-stream monitors 'daisy-chained' together or
- 2) DisplayPort multi-stream hub hub requires power through power cable provided. DisplayPort multi-stream hub provides 4 DisplayPort ports, adapters are required for support of DVI, VGA or HDMI displays.

WIRELESS DISPLAY

WiDi support with Intel® Advanced-N 6205 WLAN or Dual Band Wireless-N 7260 (mini PCI Express) and Intel® HD graphics Desktop system requirements for Intel® Wireless Display

System Component	Requirement
Processor	4th generation Intel® Core processor
Graphics	Intel® HD Graphics
Wireless	Intel Advanced-N 6205 WLAN
Software	Intel® My WiFi Technology and Intel® Wireless Display must be pre-installed and enabled.
0S*	Windows 7 32-bit/64-bit Home Premium, Ultimate, Professional; Windows 7 32-bit Home Basic

^{*} Windows 8 supports Wireless Display natively

DISPLAY

23"diagonal IPS widescreen WLED backlit anti-glare LCD display Orientation designed to operate in portrait or landscape mode Non-touch or optional touch

Projected Capacitive Touch support	s up to 10 touch-points	
Display Panel	Туре	IPS WLED Backlit LCD
	Viewable image area (mm)	509.18 x 286.42
	Touch Active Area (mm)	509.18 x 286.42 ⁶
	Screen opening (mm)	510.6 x 287.6 ⁷
	Native Resolution (HxV)	1920 x 1080
	Aspect ratio	16:9
	Pixel pitch (HxV)(mm)	0.256 x 0.256
	Contrast ratio (typical)	1000:1
	Brightness (typical)	Touch - 225nits (cd/m2)/ Non-Touch 250nits (cd/m²)
	Viewing angle (typical) (HxV)	179°x179°
	Backlight lamp life (to half brightness)	30,000 hours minimum
	Color support	Over 16 million colors
	Color gamut (typical)	72%
	Anti-glare	Yes
	Default color temperature	Warm (6500K)
	NOTE: All performance specifications represe component manufacturers; actual performan	ent the typical specifications provided by HP's nce may vary either higher or lower.

⁵Projected Capacitive Touch panel is not anti-glare

⁶With Projected Capacitive Touch Panel ⁷Without Projected Capacitive Touch Panel

Basic Stand: Tilt Angle -5° to +30°

Rotation 360° swivel

Height Adjustable / Reclining Stand: Vertical Adjustment Up to 110 mm

Recline Angle Low position sliding height adjustment => -5°

to +60°

Tilt Angle High position sliding height adjustment => -

5° to +30°

Rotation 360° swivel and portrait or landscape

orientation

WEBCAM & MIC

Optional integrated 2 MP webcam & dual microphone array; maximum resolution of 1920 x 1080

STORAGE

2.5" SATA Hard Drive

320 GB, 7200 rpm, SATA 6.0 Gb/s, SMART IV 500 GB, 7200 rpm, SATA 6.0 Gb/s, SMART IV

2.5" Solid State Drive

120 GB, SATA, Solid State Drive 128 GB, SATA, Solid State Drive 160 GB, SATA, Solid State Drive

2.5" Self-Encrypting Solid State Drive

128 GB, SATA, Self-Encrypting Solid State Drive 256 GB, SATA, Self-Encrypting Solid State Drive

2.5" Self-Encrypting Drive

500 GB, SATA, Self-Encrypting Drive

2.5" Solid State Hybrid Drive

500 GB, SATA, Solid State Hybrid Drive 1 TB SATA, Solid State Hybrid Drive

Optical Disc Drive



Standard Features and Configurable Components (availability may vary by country)

Slim Tray-load SATA DVD-ROM Slim Tray-load SATA SuperMulti DVD Writer Slim Tray-load SATA BDXL Blu-ray Writer No included Optical Disc Drive

Removable

HP Slim Removable SATA HDD frame/carrier

Media Card Reader (optional)

5-in-1 PCIe Interface Supports Secure Digital (SD, SDXC, SDHC, UHS-I, UHS-II)

PERFORMANCE

Flash Cache Module

32GB mSATA SSD Flash Cache Module (Intel® Smart Response Technology - Optional with Core Processors)

MEMORY

Type

Non-ECC, DDR3 SDRAM, 1600 MT/s, SODIMM

Maximum

16 GB

of Slots

2

204-pin supporting dual-channel memory

Maximized dual-channel performance requires SODIMMs of the same size and speed in both memory slots.

NOTE: Full availability of 4 GB or more of memory requires a 64-bit operating system. With Windows 32-bit operating systems, the amount of usable memory is dependent upon your configuration, so that above 3 GB all memory may not be available due to system resource requirements.

Memory modules support data transfer rates up to 1600 MT/s; actual data rate is determined by the system's configured processor. See processor specifications for supported memory data rate



NETWORKING/COMMUNICATIONS

Ethernet (RJ-45)

Integrated Intel® I217LM Gigabit Network Connection

NOTE: The term "10/100/1000" or "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

Wireless LAN (optional)

Intel® 802.11 a/b/g/n wireless 6205 PCIe minicard
Up to 300 mbps data rate
Intel® 802.11 a/b/g/n wireless 7260 PCIe minicard over here
Up to 300 mbps data rate
HP 802.11 a/b/g/n wireless PCIe minicard with Bluetooth Combo
Up to 300 mbps data rate
Bluetooth 4.0 compliant
Works with a wide range of Bluetooth devices

Near Field Communications (NFC) (optional)

HP Module with NXP NFC Controller with Embedded Secure Element, PN650 Supports Windows 8, Proximity Events Support Windows 7, PC/SC NFC Forum Compliant

AUDIO/MULTIMEDIA

DTS Studio Sound™

Realtek ALC 3228 Audio - 16 & 24-bit PCM

High performance integrated stereo speakers

Volume control and mute buttons

Stereo headphone jack

Microphone in

Stereo line out

Integrated 2.0 MP webcam (up to 30 frames/sec) & dual microphone array (optional)



KEYBOARDS AND POINTING DEVICES

Keyboard

HP PS/2 Keyboard 104 keys plus special functions for Mute, Volume Up, Volume Down, Sleep

Separate numeric keypad Cable length 70.87 in (180 cm)

HP USB Keyboard 104 keys plus special functions for Mute, Volume Up, Volume Down, Sleep

Separate numeric keypad Cable length 51 in (130 cm)

HP Wireless Keyboard & Mouse 104 keys plus special functions for Mute, Volume Up, Volume Down, Sleep

Separate numeric keypad; two buttons with scroll wheel acting as third button Operates at ~ 2.4 GHz and supports a working distance of up to 32 ft (10m)

Cable length 6ft (1.8m)

(Keyboard contains 25% post-consumer recycled plastic content)

HP USB SmartCard CCID Keyboard 104, 105, 106, 107, 109 layout (depending upon country)

All ISO 7816 smart cards

HP USB PS/2 Washable Keyboard SpillSeal® keyboard technology protection

USB & PS/2 support in one solution

Separate numeric keypad Cable length 7ft (2.2m)

Mice

HP PS/2 Mouse 800 dpi support

Two buttons with scroll wheel

72.8 in (185 cm)

HP USB Optical Mouse 800 dpi support

Two buttons with scroll wheel

72.8 in (185 cm)

HP USB 1000dpi Laser Mouse 1000 dpi support

Two buttons with scroll wheel Cable length 70.8 in (180 cm)

HP USB PS/2 Washable Scroll Mouse SpillSeal® mouse technology protection

Two buttons with scroll wheel 8.8 ft total 70 cm+ 2m extension



HP BIOSphere

Key features of the HP BIOS include:

- Deployment and manageability HP BIOS provides several technologies that help integrate the HP EliteOne 800 Business
 PC into the enterprise, such as PXE, remote configuration, remote control, and F10 Setup support for 12 languages.
- Select models feature either Intel® Standard Manageability or Intel® Core vPro Processor Technology.
- Stability HP BIOS supports the HP stable product roadmap by releasing only critical BIOS changes to the factory and advanced change notification.
- Support UEFI specification 2.3.1
- Computrace agent For tracking and tracing services, available in select countries, separate software and purchase of a subscription is required.
- Thermal and power management The HP BIOS provides and enables thermal and power management technologies so component temperatures are managed for high reliability and to assist in operating the HP Business Desktop computer in any enterprise environment.
- Thermal Controlled Fans Automatic or manual controlled fan speeds for cooling and acoustic performance. Serviceability
 HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery HP BIOS provides numerous ways to upgrade HP Business Desktop computers, including BIOS updates from within DOS (DOSFlash), BIOS updates from within Windows (HPQFlash), HP Client Manager, and fail-safe recovery (Emergency Boot Block Recovery). In addition, the HP Business Desktop BIOS Utilities tool enables replicated BIOS setup throughout the Enterprise; it is available from within the BIOS F10 setup and from the support website.
- HP BIOS uses PKI signing of the BIOS for trusted BIOS upgrades and recovery.
- Serviceability HP BIOS provides diagnostic and detailed service information.

Additional HP BIOS Features

- Power-On password Helps prevent an unauthorized user from powering on the system.
- Administrator password Also known as the setup password, this helps prevent unauthorized changes to the system
 configuration. If the administrator password is not known, the BIOS version cannot be changed and changes cannot be
 made to BIOS settings using F10 setup or under the OS.
- Advanced Configuration and Power Interface (ACPI) Represents a significant innovation in power and configuration
 management, allowing operating systems and applications to manage power based on activity and usage. HP Elite models
 use ACPI to provide power conservation features.
- S5 Max Power Savings setting supports EU Lot6 requirement and allows the computer to power down below 1W is S5
 (when turned off). When S5 Max Power Savings feature is enabled power to slots is turned off along with WOL functionality.
- Master Boot Record Security Helps to prevent changes and/or infections to the Master Boot Record caused by viruses or malicious code.
- HP BIOS Protection prevents unauthorized updates or changes to the BIOS due to malware, viruses, or malicious BIOS updates. Based on NIST SP800-147 policy guidelines.



SECURITY

USB port disable Lockable Access Panel Lockable I/O security cover

Security Screw

HP Keyed Cable Lock (optional)

Common Criteria Certified, Infineon TPM SLB9656TT1.2-4.32 FW

Intrusion Detector

Wall/Arm/Cart Mountable via VESA bracket

Support for Nobel Locking Plate (3rd party option)

Support for 3M Privacy Screen (3rd party option), for non-touch models

POWER

Internal 200W, up to 93% efficient, active PFC 100-240V AC

Loading	20)%	50)%	10	0%
Power Efficiency	90%	90%	93%	92%	91%	89%
Volts	230	100/115	230	100/115	230	100/115

SOFTWARE COMPONENTS AND APPLICATIONS WITH WINDOWS

Included	Windows 7	Windows 8
Security	Computrace (status tracing) ¹ Device Access Manager Drive Encryption ² File Sanitizer (Activated via Wizard) Disk Sanitizer (External Version) ³ Microsoft Security Essentials Security Manager	Computrace (status tracing) ¹ Device Access Manager Drive Encryption ² File Sanitizer (Activated via Wizard) Disk Sanitizer (External Version) ³ Microsoft Defender Secure Erase Security Manager
Multimedia	Cyberlink Power DVD, BD Cyberlink Power2Go (Secure Burn)	Cyberlink Power DVD, BD Cyberlink Power2Go (Secure Burn)
Communication		HP Wireless Hotspot
HP Value Add	HP ePrint Driver ⁵ HP PageLift HP Support Assistant HP Recovery Disk Creator	HP ePrint Driver ⁵ HP PageLift HP Recovery Manager HP Support Assistant HP Quick Start ⁶
3rd Party	Adobe Flash Player Bing Search for Internet Explorer 10 Box ⁷ PDF Complete, Corporate Edition Skype	Bing Search ⁷ PDF Complete, Corporate Edition Skype
Microsoft Products	Buy Office	Buy Office

¹Computrace agent is shipped turned off, and must be activated by customers when they purchase a subscription. Subscriptions can be purchased for terms ranging from one to five years. Service is limited, check with Absolute for availability outside the U.S.



²Drive Encryption is planned to be available in October 2013. Requires Windows. Data is protected prior to Drive Encryption login. Turning the PC off or into hibernate logs out of Drive Encryption and prevents data access.

³Available via download

⁴Preinstalled on models with webcam

⁵Requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see www.hp.com/go/eprintcenter). Requires optional broadband module. Broadband use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Separately purchased data plans or usage fees may apply. Print times and connection speeds may vary.

⁶Non-Touch model only

⁷UK only

ENVIRONMENTAL & INDUSTRY

ENERGY STAR® qualified models available

EPEAT® registered where applicable/supported. See www.epeat.net for registration status by country.

Industry standard certifications:

UL

CSA

FCC compliance

ENERGY STAR®

EPEAT® Gold

EUP Lot6 Tier2

CCC

CECP

SEPA

TCO AiO and TCO Edge

Optimized for Microsoft Lync

Low halogen

Arsenic Free

80 PLUS®

TAA compliant

For accessibility information on HP products, please visit: http://www.hp.com/accessibility.



WEIGHTS & DIMENSIONS

Weight with Touch Panel

Product Weight	Without stand	Basic stand	Height adjustable/reclining stand
Unboxed	19.3 - 19.7 lbs	24.1 - 24.5 lbs	33.4 - 33.9 lbs
	8.74 - 8.94 kg	10.91 - 11.11 kg	15.17 - 15.37 kg
Shipping Weight	Without stand	Basic stand	Height adjustable/reclining stand
Boxed	28.38 lbs	31.39 lbs	41.68 lbs
	12.87 kg	14.24 kg	18.91 kg
61: :	1.00	D :	

Shipping Weight Without stand (24 units) Basic stand (24 units) Height adjustable/reclining stand (12 units) (12 units)

270 kg 361 kg 542.16 lbs 245.92 kg

Weight without Touch Panel

Product Weight	Without stand	Basic stand	Height adjustable/reclining stand
Unboxed	17.4 - 17.8 lbs	22.2 - 22.6 lbs	31.6 - 32 lbs
	7.89 - 8.09 kg	10.06 - 10.26 kg	14.32 - 14.52 kg
Shipping Weight	Without stand	Basic stand	Height adjustable/reclining stand
Box	26.06 lbs	29.23 lbs	39.38 lbs
	11.82 kg	13.26 kg	17.86 kg
Shipping Weight	Without stand (24 units)	Basic stand (24 units)	Height adjustable/reclining stand
Pallet	510.41 lbs	743.49 lbs	(12 units)
	231.48 kg	337.24 kg	514.38 lbs

Dimensions (W x D x H)

Product Dimensions	Without stand	Basic stand	Height adjustable/reclining stand
	22 x 1.98 x 15.3 in	22 x 6 x 17.2 in	0 degrees
	560 x 50.3 x 389 mm	560 x 153.4 x 437.2 mm	22 x 7.7 x 20.8 in
			560 x 194.8 x 528.9 mm

Height adjustable/reclining stand 60 degrees

233.32 kg

22 x 14.6 x 10.5 in 560 x 370.2 x 265.9 mm

Height adjustable/reclining stand

Shipping Dimensions *Shippina Dimensions*

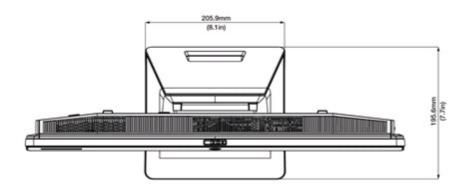
Without stand

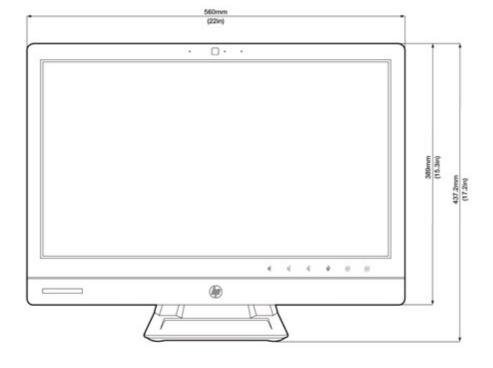
July Dimensions	TTTCTTO GE STUTIO	Dusic starra	ricigite dajastaste, rectining staria
Boxed	25.83 x 10.59 x 20.39 in	25.83 x 10.59 x 20.39 in	26.46 x 12.56 x 21.10 in
	656 x 269 x 518 mm	656 x 269 x 518 mm	672 x 319 x 536 mm
Shipping Dimensions	Without stand (24 units)	Basic stand (24 units)	Height adjustable/reclining stand
Pallet	47.24 x 39.37 x 86.30 in	47.24 x 39.37 x 86.30 in	(12 units)
	1200 x 1000 x 2129 mm	1200 x 1000 x 2129 mm	47.24 x 39.37 x 68.03 in
			1200 x 1000 x 1728 mm

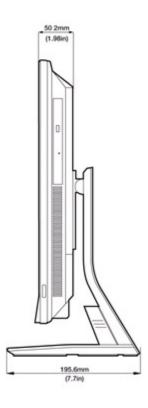
Basic stand



BASIC STAND DIMENSIONS

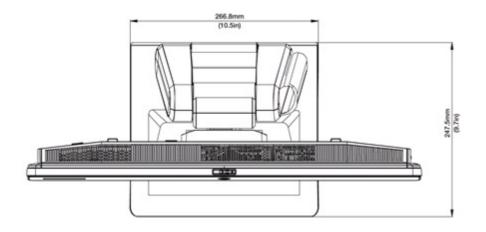


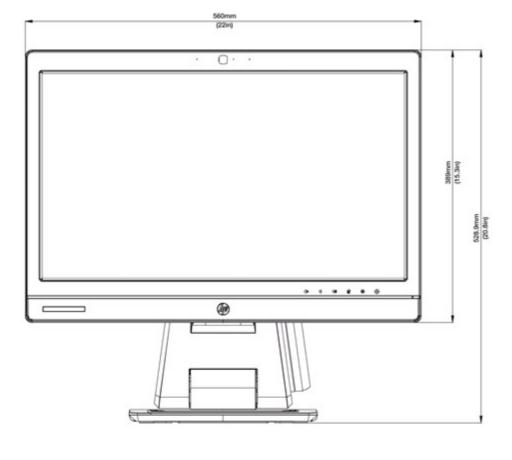


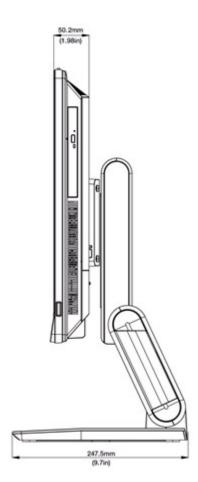


Standard Features and Configurable Components (availability may vary by country)

HEIGHT ADJUSTABLE/RECLINING STAND DIMENSIONS







TEMPERATURE, HUMIDITY, ALTITUDE

Temperature Operating 50° to 95° F (10° to 35° C)*

Non-operating -22° to 140° F(-30° to 60° C)

Relative humidity Operating 10% to 90% (non-condensing at ambient)

Non-operating 5% to 95% (non-condensing at ambient)

Altitude Operating 10,000 ft (3048 m) (unpressurized) Non-operating 30,000 ft (9144 m)

PORTS

I/O Ports - Standard

6 - USB 3.0 (2 side including 1 fast charging, 4 rear)

USB Fast Charging Port:

- Up to 2.5A charging current (5 times the maximum current supported by a USB 2.0 port; 2.8 times the maximum current supported by a USB 3.0 port)
- D+/D- CDP/DCP Modes per USB Battery Charging Specification 1.2
- D+/D- Shorted Mode per Chinese Telecommunication Industry Standard YD/T 1591-2009
- Supports non-BC1.2 Charging Modes by Automatic Selection
- D+/D- Divider Modes 2.0V/2.7V and 2.7/2.0V
- D+/D- 1.2V Mode
- Supports Sleep-Mode Charging
- Automatic SDP/CDP Switching for Devices That do not Connect to CDP Ports
- 2 PS/2 (legacy) (one keyboard, one mouse)
- 1 Microphone in (side)
- 1 Headphone jack (side)
- 1 Serial RS-232 (rear)
- 1 Stereo audio line out (rear)
- 1 Power connector (rear)
- 1 RJ-45 (rear)
- 1 DisplayPort with multi-stream¹¹

DisplayPort connector supports multimode technology to support connection to DVI-D, HDMI and VGA monitors with optional adapters or to a DisplayPort monitor with a DisplayPort Cable.

DisplayPort Cable Provides a direct connection between the PC's DisplayPort interface to the display's

DisplayPort interface

DisplayPort To DVI-D Adapter Provides a connection from the PC's DisplayPort interface to the display's DVI-D interface;

adapts the DP output to the DVI-D input

DisplayPort To HDMI Adapter Provides a connection from the PC's DisplayPort interface to the display's HDMI interface;

adapts the DP output to the HDMI input

DisplayPort To VGA Adapter Provides a connection from the PC's DisplayPort interface to the display's analog VGA

interface; adapts the digital DP output to the analog VGA input



¹¹Using the Integrated Graphics, two (2) external displays are supported via one of these methods: Using the MXM Graphics, up to four (4) external displays are supported via one of these methods:

- 1) DisplayPort multi-stream monitors 'daisy-chained' together or
- 2) DisplayPort multi-stream hub hub requires power through power cable provided. DisplayPort multi-stream hub provides 4 DisplayPort ports, adapters are required for support of DVI, VGA or HDMI displays.

SLOTS

- 1 Mini PCIe half-length (used by wireless LAN module)
- 1 MXM 3.0 Type A 35W
- 1 mSATA

BAYS

- 1 2.5" internal; Supports up to Two 2.5" hard drives (HDD/SSD/SED/SSHD)
- 1 5.25" external; Slim Line Optical Drive

SERVICE AND SUPPORT

On-site Warranty¹: Three-year (3-3-3) limited warranty delivers three years of on-site, next business day² service for parts and labor and includes free telephone support³ 24 x 7. Three-year onsite and labor are not available in all countries. Service offers terms up to 5 years by choosing a Care Pack. To choose the right level of service for your HP product, visit HP Care Pack Central: www.hp.com/go/cpc

NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. Other warranty variations may be offered in your region.

NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

NOTE 3: Technical telephone support applies only to HP-configured Compaq and third-party HP qualified hardware and software. Toll-free calling and 24 x 7 support may not be available in some countries.



Technical Specifications - Graphics

Intel HD Graphics

VGA Controller Integrated

DisplayPort Multimode capable; supports HDCP, Display Port Audio (2 streams), HBR2 link rates and Multi-Stream

Technology for a maximum of 3 displays (including the integrated panel)

Bus Type N/A RAMDAC N/A

Memory Intel graphics do not have dedicated memory but utilizes some of the computer's system memory The

amount of memory used for graphics depending on the amount of system memory installed, BIOS settings, operating system, and system load. 32 MB is pre-allocated for graphics use at system boot time. Additional memory can be allocated at boot time by the BIOS for PAVP (Protected Audio Video Playback)

support for playback of protected video content.

Additional memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology

(DVMT), to provide an optimal balance between graphics and system memory use.

Maximum Graphics Memory Microsoft Windows 7 Windows 8

Up to 1.7GB Up to 1.8GB

NOTE: the actual amount of maximum graphics memory can be less than the amounts listed above depending upon your computer's configuration.

Maximum Color Depth Graphics/Video API Support 32 bits/pixel

4th Generation Core processors:

- The Processor Graphics contains a refresh of the seventh generation graphics core enabling substantial gains in performance and lower power consumption. Up to 16 EU support.
- Next Generation Intel Clear Video Technology HD Support is a collection of video playback and enhancement features that improve the end user's viewing experience
 - Encode/transcode HD content
 - Playback of high definition content including Blu-ray Disc
 - Superior image quality with sharper, more colorful images
- DirectX Video Acceleration (DXVA) support for accelerating video processing o Full AVC/VC1/MPEG2 HW Decode
- Advanced Scheduler 2.0, 1.0
- Windows 7, Windows 8, Linux OS Support
- DirectX 11.1
- OpenGL 4.0
- Open CL 1.2



Technical Specifications - Graphics

Supported Display Resolutions and Refresh Rates

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

•	
Resolution	Refresh Rates
800x600	60 Hz
1024x768	60 Hz
1152x864	60 Hz
1280x600	60 Hz
1280x720	60 Hz
1280x800	60 Hz
1280x960	60 Hz
1280x1024	60 Hz
1360x768	60 Hz
1366x768	60 Hz
1400x1050	60 Hz
1440x900	60 Hz
1600x900	60 Hz
1600x1200*	60 Hz
1680x1050	60 Hz
1920x1080	60 Hz
1920x1200*	60 Hz
1920x1440*	60 Hz
2560x1440*	60 Hz
2560x1600*	60 Hz

^{*} Only supported on displays connected to the external DisplayPort connector.

AMD Radeon HD 7650A Graphics Card

Form Factor MXM 3.0

Graphics Controller AMD Radeon HD 7650A

DisplayPort Multi-Stream Technology for a maximum of 5 displays (including the integrated panel)

Core Clock 600MHz Memory Clock 800MHz

Memory 2GB, DDR3, 128-bit wide

Bus Type MXM **Max. Power** 35W

Power Source Support 12V and 19V **3D API Support** DX11, SMS

HDCP Support Yes

Display Max. ResolutionDigital 2560 x 1600
Analog 2048 x 1536

Supported Graphics APIs DX11, OpenGL, full 1080p BD (H264) playback in hardware, Multi-Stream DisplayPort support



Technical Specifications - Graphics

Supported Display Resolutions and Refresh Rates

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Refresh Rates
800 x 600	60 Hz
1024 x 768	60 Hz
1280 x 720	60 Hz
1280 x 768	60 Hz
1280 x 1024	60 Hz
1360 x 768	60 Hz
1440 x 900	60 Hz
1600 x 900	60 Hz
1680 x 1050	60 Hz
1920 x 1080	60 Hz



Technical Specifications – Hard Disk and Solid State Storage

Introduction:

HP Serial Advanced Technology Attachment (SATA) Hard Drives maximize the performance of HP Business PCs by providing the technologies to meet your increasing storage demands with high-capacity drives offering superior reliability and performance.

SATA provides faster data transfer speeds, better system cooling airflow, more bandwidth, more headroom for speed increases in future generations and better data integrity. A next-generation technology, the SATA interface connects hard drives to the PC platform enabling easy aggregation of multiple hard drives into a single PC. This offers you the additional benefits of dedicated bandwidth, the ability to more easily identify device failures and scalability. The HP Elite 800 Series supports the latest SATA 6.0Gb/s specification.

HP Drive Lock

HP Serial ATA Hard Drives offer enhanced security via a new Drive Lock. When enabled, this ATA security feature set prevents software access to user data on the drive until one or two user-defined passwords are provided.

SMART IV Technology

Self Monitoring Analysis and Reporting Technology (SMART) hard drive technology allows hard drives to monitor their own health and to raise flags if imminent failures are predicted. If the drive determines that a failure is imminent, the SMART hard drive technology enables the intelligent manageability or management software to generate a fault alert. While the current versions of SMART hard drives do a good job monitoring the data on the hard drive media, the ever increasing emphasis on reliability and quality has promoted HP to implement SMART IV technology which constantly checks that the data flow from host interface to media and media to host interface is not compromised. This is accomplished by inserting a 2 byte parity code into every 512 byte block in the data path of the hard drive's Cache RAM. This unique parity checking performed by HP's SMART IV technology hard drives, allows for more complete error detection coverage encompassing the entire data path between the host and the hard drive.

Smart IV is also known as IOEDC: I/O Error Detection Code.

Native Command Queuing

NCQ or Native Command Queuing is a SATA protocol extension that allows the hard drive to have several write or read commands outstanding at the same time. In contrast, normal non-queued operation requires each command to be completed before the next command is issued by the host system. Queuing allows the drive to complete the commands in the order that allows for best overall throughput. It also involves an advanced method of transferring data to or from the host, called First Party Direct Memory Access (FPDMA), which allows the hard drive and the host controller to manage the data transfers for multiple outstanding commands, without involving the host processor. NCQ can contribute to better performance but the results are dependent on many factors, including the access patterns of the various applications and operating system functions that are initiating drive accesses. Enabling NCQ features in the hard drive requires AHCI support from the host system BIOS, controller, and driver. AHCI support is typically implemented in RAID configurations.

NOTE: GB = 1 billion bytes. Actual available capacity is less.



Technical Specifications – Hard Disk and Solid State Storage

HP 320-GB 7.2K SATA 6.0Gb/s 2.5" Hard Disk Drive

Capacity 320,072,933,376 bytes

Rotational Speed 7,200 rpm
Interface SATA 6 Gb/s
Buffer Size 16 MB
Logical Blocks 488,397,168

Seek Time (typical reads, includes controller overhead, including settling)

Single Track: 2.0 ms

Average: 12 ms

Full-Stroke: 22 ms

Height (nominal) 0.374 in/9.5 mm

Width (nominal)

Media diameter: 2.5 in/63.5 mm
Physical size: 2.75 in/70 mm

Operating Temperature

41° to 131° F (5° to 55° C)

HP 500-GB 7.2K SATA 6.0Gb/s 2.5" Hard Disk Drive

Capacity 500,107,862,016 bytes

Rotational Speed 7,200 rpm
Interface SATA 6 Gb/s
Buffer Size 16 MB

Logical Blocks 976,773,168

Seek Time (typical reads, includes controller overhead, including settling)

Single Track: 2.0 ms

Average: 12 ms

Full-Stroke: 25 ms

Height (nominal) 0.374 in/9.5 mm

Width (nominal) Media diameter: 2.5 in/63.5 mm

Physical size: 2.75 in/70 mm

Operating Temperature 41° to 131° F (5° to 55° C)



Technical Specifications – Hard Disk and Solid State Storage

HP 120-GB Solid State Drive

Unformatted Capacity

Architecture Multi Level Cell (MLC) NAND Flash with wear leveling 10 channel controller

Interface SATA 3 Gb/s

Dimensions (W x H x D) 2.74 x 0.37 x 4 in (6.98 x 0.95 x 10.2 cm)

Weight 0.18 lb (80 q)

Sustained Sequential Read: Up to 250 MB/s

Sustained Sequential Write: Up to 70 MB/s

Bandwidth Performance Random Read: Up to 35K IOPs

Random Write: Up to 6.6K IOPs

Read: 65-ms

Latency Write: 85-ms

DC power requirement: 5 VDC 5%-100 mV ripple p-p

Total power consumption: 0.15W (active); 0.075W (idle)

Useful Drive Life 35TB written, up to 20GB/day for 5 years

Operating Temperature: 32° to 158° F (0° to 70° C)

Relative Humidity: 5% to 95%

Maximum Wet Bulb (all conditions, non-condensing)

Temperature (operating):

Shock: 1,500 G/0.5-ms

HP 128 GB Solid State Drive

Unformatted Capacity 128 GB*

Architecture Multi Level Cell (MLC) NAND

Interface SATA 6 GB/sec

Dimensions (W \times H \times D) 2.75 x 0.276 x 3.96 in (6.985 x 0.7 x 10.05 cm)

Weight 0.16 lb (73 q)

Bandwidth Performance

Sustained Sequential Read: Up to 450 MB/s

Sustained Sequential Write: Up to 260 MB/s

Random Read: up to 46K IOPs

Random Write: up to 56K IOPs

Read: 55ms (TYP)

Latency Write: 55ms (TYP)

DC power requirement: Min 4.5 V; Max 5.5 V

Power Total power consumption: 160 mW (Active); <85 mW; (Idle)

Useful Drive Life 1.2 million device hours**

Operating Temperature: 32° to 158° F (0° to 70° C)

Relative Humidity: 5% to 95%

P........

Power

Environmental

Technical Specifications – Hard Disk and Solid State Storage

Environmental

Latency

(all conditions, non-condensing)

Maximum Wet Bulb 84° F (29° C) Temperature (operating):

Shock: 1,500 G/1.0 msec

UL, CSA, EN 60950-2000, CISPR Pub 22 Class B, CNS 13438, AS/NZS Regulations

CISPR 22:2002 Class B, Korea KCC, CE Mark

* For solid state disk drives, GB means 1 billion bytes. 128GB is the unformatted capacity of this drive before a portion of the drive is reserved for flash management features. Actual capacity will vary by content

** The product achieves a mean time between failure (MTBF) based on population statistics not relevant to individual units.

HP 160 GB Solid State Drive

Unformatted Capacity 160 GB*

Architecture Multi Level Cell (MLC) NAND

Interface SATA 3 GB/sec

Dimensions (W \times H \times D) 2.74 x 0.37 x 4 in (6.98 x 0.95 x 10.2 cm)

Weight 0.18 lb (80 q)

Sustained Sequential Read: Up to 250 MB/s

Sustained Sequential Write: Up to 70 MB/s

Bandwidth Performance

Random Read: up to 35K IOPs

Random Write: up to 6.6K IOPs

Read: 65 ms

Write: 85 ms

DC power requirement: 5 VDC 5%-100 mV ripple p-p Power

Total power consumption: 0.15 Watt (Active); 0.075 Watt (Idle)

Useful Drive Life 35TB written, up to 20GB/day for 5 years **

Operating Temperature: 32° to 158° F (0° to 70° C)

Environmental Relative Humidity: 5% to 95%

(all conditions, non-condensing)

Shock: 1,500 G/0.5 msec

UL, CSA, EN 60950-2000, CISPR Pub 22 Class B, CNS 13438, AS/NZS CISPR 22:2002 Class B, Korea Regulations

KCC, CE Mark



^{*} For solid state disk drives, GB means 1 billion bytes. 128GB is the unformatted capacity of this drive before a portion of the drive is reserved for flash management features. Actual capacity will vary by content

^{**} The product achieves a mean time between failure (MTBF) based on population statistics not relevant to individual units.

Technical Specifications – Hard Disk and Solid State Storage

HP 256 GB SATA 2.5" Self-Encrypting (SED) Solid State Drive

Unformatted Capacity 256,186,209,271 bytes

Self-Encrypting (SED) Solid State Drive with 25nm MLC NAND Flash and SATA interface **Architecture**

Interface SATA 6 Gb/s

NAND Flash 25nm MLC NAND Flash

.275 in/7mm Height Width 2.75 in/69.85 mm Length 3.95 in/100.5 mm Weight 0.161 lb (73 g)

Sustained Sequential 128k Up to 450 MB/s

Read:

Sustained Sequential 128k Up to 260 MB/s **Write: Bandwidth Performance**

Random 4k Read: Up to 46K IOPs Random 4k Write: Up to 56K IOPs

> Read: 55 µs Write: 55 µs

SATA power consumption: 160 mW (active average); <85 mW (idle average) Power

Useful Drive Life 72TB written, up to 40GB/day for 5 years

Operating Temperature: 32° to 158° F (0° to 70° C)

Environmental (all conditions, non-condensing)

Relative Humidity: 5% to 95%

Shock: 1,500 G/1 ms

HP 500-GB 7200 RPM SATA 2.5" Self-Encrypting (SED) Hard Disk Drive

Capacity 500,107,862,016 bytes

Rotational Speed 7,200 rpm

Drive Type Self-Encrypting Drive (SED) with SATA interface

Interface SATA 6 Gb/s

Segmented Buffer with write 32768 KB - A portion of buffer capacity used for firmware

cache

Latency

Number of Sectors 976,773,168

Single Track: 1.0 ms

Seek Time (typical reads) Average: 13 ms

Full-Stroke: 25 ms

Media Diameter 2.5 in/63.5 mm

Height 0.267 in/6.8 mm, ±0.2mm Width 2.75 in/69.85 mm, ±0.25mm 3.945 in/100.2 mm, ±0.25mm Length

Weight 3.35 oz/95 g (max)



Technical Specifications – Hard Disk and Solid State Storage

Operating Temperature 32° to 140° F (0° to 60° C)

HP 500 GB SATA 6G 2.5" 8GB Solid State Hybrid Drive (SSHD)

Formatted Capacity 500 GB

Spindle Speed 5,400 rpm +/- 0.2%

Drive Type Solid State Hybrid Drive (SSHD) technology with NAND Flash

Interface SATA 6 Gb/s

Cache Buffer64 MBNAND Flash8 GB

Commercial Multilevel Cell

(cMLC)

Number of Sectors 976,773,168

Seek Time (typical reads)

Single Track: 2.0 ms

Average: 12 ms

Height 0.268 +/-.008 in (6.8 +/- 0.2 mm)

Width 2.750 +/- 0.010 in (69.85 +/- 0.25 mm)

Length 3.951 +0.008 / -0.010 in (100.35 +0.20 / -0.25 mm)

Weight 0.209 lb/95 g (max)

Operating Temperature 32° to 140° F (0° to 60° C)

HP 1-TB SATA 6G 2.5" 8GB Solid State Hybrid Drive (SSHD)

Formatted Capacity 1 TB

Spindle Speed 5,400 rpm +/- 0.2%

Drive Type Solid State Hybrid Drive (SSHD) technology with NAND Flash

Interface SATA 6 Gb/s

Cache Buffer64 MBNAND Flash8 GB

Commercial Multilevel Cell

(cMLC)

Number of Sectors 976,773,168

Seek Time (typical reads)

Average: 12 ms

Height 0.374 +/-.008 in (9.5 +/- 0.2 mm) **Width** 2.750 +/- 0.010 in (69.85 +/- 0.25 mm)

Length 3.951 +0.008 / -0.010 in (100.35 +0.20 / -0.25 mm)

Weight 0.254 lb/115 g (max)

Operating Temperature 32° to 140° F (0° to 60° C)



Technical Specifications - Removable Storage

HP Slim SuperMulti DVD Writer Drive

Height 12.7mm height

Orientation Either horizontal or vertical

Interface type SATA/ATAPI

Disc recording capacity Up to 8.5 GB DL or 4.7 GB standard

Dimensions (W x H x D) 5.0 x 0.5 x 5.0 in (128 x 13.6 x 129 mm)

Weight (max) 0.42 lb (190 g)

DVD-RAM Up to 5X

DVD-R DL Up to 6X

DVD+R Up to 8X

DVD+RW Up to 8X

Write speeds DVD+R DL Up to 6X

DVD-R Up to 8X

DVD-RW Up to 6X

CD-R Up to 24X

CD-RW Up to 24X

DVD-RAM Up to 5X

DVD-RW, DVD+RW Up to 8X

DVD-R DL, DVD+R DL Up to 8X

Read speeds DVD+R, DVD-R Up to 8X

DVD-ROM DL, DVD-ROM Up to 8X

CD-ROM, CD-R Up to 24X

CD-RW Up to 24X

Access time DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical)

(typical reads, including Full Stroke DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical)

Stop Time 6 seconds typical

Source Slimline SATA DC power receptacle

Power DC Power Requirement 5 VDC ± 5%-100 mV ripple p-p

DC Current 5 VDC (< 1000 mA typical, 1600 mA maximum)



settling)

Technical Specifications - Removable Storage

Temperature 41° to 122° F (5° to 50° C)

Environmental conditions

(operating - non-condensing) Maximum Wet Bulb

10% to 90% 84° F (29° C)

Temperature

Relative Humidity

HP Slim Blu-ray BDXL Drive

Height 12.7mm height

Orientation Either horizontal or vertical

Interface type SATA/ATAPI

Disc recording capacity Up to 128 GB QL, 100 GB TL, 50 GB DL or 25 GB standard SL

Dimensions (W x H x D) 5.04 x 0.5 x 5.0 in (128 x 12.7 x 127 mm) without bezel

Weight (max) Up to 0.37 lb (170 g) without bezel

Write speeds Triple-layer Quadruple-layer

BD-R Up to 4X Up to 4X

BD-RE Up to 2X Not supported

Single-layer Double-layer

 BD-R
 Up to 6X
 Up to 6X

 BD-RE
 Up to 2X
 Up to 2X

DVD-R Up to 8X Up to 6X

DVD-RW Up to 6X Not supported

DVD+R Up to 8X Up to 6X

DVD+RW Up to 8X Not supported

 DVD-RAM
 Up to 5X
 N/A

 CD-R
 Up to 24X
 N/A

CD-RW Up to 24X N/A

Triple-layer Quadruple-layer

BD-R Up to 4X Up to 4X

BD-RE Up to 4X Not supported

Single-layer Double-layer

Technical Specifications - Removable Storage

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Technical Specifications - Removable Storage

HP Slim DVD-ROM Drive

Height 12.7mm

Orientation Either horizontal or vertical

Interface type SATA/ATAPI

Dimensions (W x H x D) 5.04 x 0.5 x 5.0 in (128 x 12.7 x 127 mm) without bezel

Weight (max) Up to 0.37 lb (170 g) without bezel

DVD+R/-R/+RW/ Up to 8X

-RW/+R DL /-R DL

Read speeds DVD-ROM Up to 8X

CD-ROM, CD-R Up to 24X

CD-RW Up to 24X

Access time Random DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical)

(typical reads, including

settling) Full Stroke DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical)

Source Slimline SATA DC power receptacle

Power DC Power Requirement 5 VDC ± 5%-100 mV ripple p-p

DC Current 5 VDC - <1000 mA typical, < 1600 mA maximum

Temperature 41° to 122° F (5° to 50° C)

Environmental (all conditions

non-condensing)

Relative Humidity

Relative Hullilaity

Maximum Wet Bulb

Temperature (operating)

10% to 80% 84° F (29° C)



Technical Specifications – Memory

System Memory Support

The HP EliteOne 800 G1 All-in-One Business PC supports the 4th generation Intel® Core™ processor families. Based on a new PC microarchitecture, the processor is designed for a two-chip platform consisting of a processor and Platform Controller Hub (PCH). Unlike previous generations, the processor includes an integrated memory controller (IMC). The IMC supports DDR3 protocols with two independent, 64-bit wide channels each accessing one SODIMM.

- Two channels of non-ECC DDR3 unbuffered small outline dual in-line memory modules (SODIMM) with a maximum of one SODIMM per channel
- Single-channel and dual-channel memory organization modes
- Data burst length of eight for all memory organization modes
- DDR3 memory data transfer rates of up to 1600 MT/s; actual supported DDR3 data transfer rate determined by the configured processor
- 64-bit wide channels
- DDR3 system memory I/O voltage of 1.5V and 1.35V
- Theoretical Maximum Memory Bandwidth:
 - 10.6 GB/s in single-channel mode of 21.3 GB/s in dual-channel mode assuming DDR3 1333 MT/s
 - 12.8 GB/s in single-channel mode or 25.6 GB/s in dual-channel mode assuming DDR3 1600 MT/s
 - O 16 GB maximum memory support

CAUTION: You must shut down the computer and disconnect the power cord before adding or removing memory modules. Regardless of the power-on state, voltage is always supplied to the memory modules as long as the computer is plugged in to an active AC outlet. Adding or removing memory modules while voltage is present may cause irreparable damage to the memory modules or system board.

Memory Configurations:

Slot 1 must always be populated. Not all memory configurations possible are represented below.

NOTE: For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system.

Total Memory	Socket	
	Channel A (black)	Channel B (black)
2 GB	2 GB	Unpopulated
4 GB	4 GB	Unpopulated
8 GB (dual channel)	4 GB	4 GB
8 GB	8 GB	Unpopulated
16 GB (dual channel)	8 GB	8 GB



Technical Specifications - Communications

Intel® I217LM GbE Network Connection (integrated)

Connector RJ-45

System Interface Integrated on PCA

Controller Intel® Ethernet Controller I217LM

Memory 24 KB FIFO packet buffer memory Two Queues (Tx & Rx)

Data rates supported 10/100/1000 Mbps

802.1P 802.1Q

802.1as/1588

IEEE Compliance 802.3

802.3ab 802.3az 802.3u

Bus architecture PCI Express and SMBus

Data transfer mode PCIe-based interface for active state operation (SO state) and SMBus for host and management

traffic (Sx low power state)

Power requirement Requires 3.3Vdc with integrated regulators

Thermal Design Power (TDP) 0.535 Watts

Boot ROM support Yes

Network transfer mode Full-duplex

Half-duplex (not supported for the 1000BASE-T transceiver)

Network transfer rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Environmental Operating Temperature: 0° to 85° C

Operating Humidity: 60% RH

Management WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, Advanced cable diagnostic, Smart speed

operation

Alerting ASF 2.0 support; AMT 7.0 support

Intel Centrino Advance-N 6205 Wireless Network Interface Connection

Wireless LAN Standards IEEE 802.11a/b/g/n

IEEE 802.11 e, 802.11i, 802.11d, 802.11h

Interoperability Wi-Fi certified (802.11 a/b/g/n WMM, WPA, WPA2 and WPS)

Tested with wireless access points from several major manufacturers

OS compatible with Microsoft Windows, Win7 and XP

Cisco Compatible Extensions Program compliant (802.11a/b/g only) with Microsoft Windows XP and

Windows 7

Frequency Band 2.4 GHz and 5 GHz



Technical Specifications - Communications

Antenna Structure 2 transmit; 2 receive (2x2)

Data Rates 802.11b: 1, 2, 5.5, 11 Mbps

802.11a/g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: 66 possible data rates, ranging from 6 Mbps to 300 Mbps, depending on the combination of

Bandwidth, Modulation Coding Scheme, and Guard Interval used, as defined in IEEE 802.11n

specification

Modulation Direct Sequence Spread Spectrum

DBPSK, DQPSK, CCK, OFDM, BPSK, QPSK, 16-QAM, 64-QAM

Security Supports 64- and 128-bit WEP, WPA, WPA2, hardware-accelerated AES (support for key sizes of

128bits), TKIP, 802.1x authentication types EAP-TLS, EAP-TTLS, PEAP, MSCHAP, PEAP-MSCHAPv2,

LEAP, EAP-FAST, EAP-SIM, EAP-AKA PAP, CHAP, TLS, GTC

Support for Cisco Security Features (proven compatibility with Cisco Aironet infrastructure products through the Cisco Compatible Extensions Program Version 4) with Microsoft Windows XP only.

Sub-channels Multinational support with frequency bands and channels compliant to local regulations.

Media Access Protocol CSMA/CA (Collision Avoidance) with ACK

Network Architecture Models Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)
Intel® My Wifi Technology (iPAN)

Roaming Provide seamless roaming between like access points (same frequency band)

Output Power (for CCK) 15 dBm
Output Power (for OFDM: power 15 dBm

varies by data rate)

Power Consumption Transmit: 2.3 Watts (average, with one spatial streams)

Receive: 1.9 Watts (average with two receive chains)

Idle mode: 30mW - 40mW (average)

Radio off: 20 mW (max)

Power Management ACPI compliant power management

802.11 compliant power saving mode

Antenna Connections 3 U.FL type connectors, 50 ohm nominal impedance

Range 802.11 a - Typical (@6 Mbps) 600 feet - Outdoor Open Area

150 feet - Indoor, Office environment

802.11 b - Typical (@1 Mbps)

300 feet - Indoor, Office environment

802.11 g - Typical (@1 Mbps)

1200 feet - Outdoor Open Area

300 feet - Indoor, Office environment

Form Factor MiniPCI-Express
Weight 0.013 lb (4.0 q)

Dimensions 1.1 x 1.2 in (26.8 x 30.0 mm) **Operating Voltage** 3.3V +/- 9%, 1.5V +/- 5%

Temperature Operating: 32° to 176° F (0° to 80° C)

Non-operating: -40° to 176° F (-40° to 80° C)

Humidity Operating: 10% to 90% (non-condensing)

Non-operating: 5% to 90% (non-condensing)

Technical Specifications - Communications

Microsoft Windows XP

Microsoft Windows Win 7

Configuration Utility

 Microsoft Windows XP Wireless Network **Connection Manager**

 Intel PROSet for Microsoft Windows XP (required for Cisco Compatible Extensions

support)

 Intel IHV extensions for Win7 available to support Cisco Compatible Extensions

HP WLAN 802.11a/b/g/n Wireless 2x2 Dual-Band Minicard with Bluetooth Combo

Dimensions (L x H) 1.18 x 1.06 in (30 x 26.8 mm)

Chipset Atheros AR9462 System interface PCI-Express Mini Card **Network standard** 802.11 a/b/g/n

Bluetooth: 2.402 - 2.480 GHz

Wi-Fi:

Frequency band 802.11a/n - 4.9 - 4.95 GHz (Japan), 5.15 - 5.25 GHz, 5.25 - 5.35 GHz, 5.47 - 5.725 GHz, 5.825 - 5.850

GHz

802.11b/g/n 2.402-2.482 GHz

The WLAN + Bluetooth Combo Mini Card meets all of the requirements to support Bluetooth 4.0 and Bluetooth

is backwards compatible with 2.1 with EDR and 3.0 High speed.

Operating temperature 14° to 158°F, operating (-10° to 70°C, operating)

Storage temperature -40° to 176°F, non-operating (-40° to 80°C, non-operating)

10-90% operating Humidity 5-95% non-operating

Operating voltage 3.3 V ±9% I/O supply voltage

Platform/WLAN Mode	Power Consumpti	on
--------------------	-----------------	----

250mW

100mW

Wi-Fi

Transmit Mode 2 W Receive Mode 1.6 W Idle mode (PSP)

(WLAN Associated)

Power Consumption Idle mode

(WLAN unassociated)

Radio disabled 75mW

Bluetooth

Peak Operating 330 mW Receive 230 mW 17 mW **USB Selective Suspend**

2.4G: +13.5dBm minimum **Output Power** (approximate) 5G: +12dBm minimum



Security

Technical Specifications - Communications

IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only

802.1x authentication

WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES

IEEE 802.11i

Cisco Certified Extensions, all versions through V5

WAPI

Antenna Dual antenna connectors

Near Field Communications Controller, with Embedded Secure Element

Dimensions (L x W x H) Module 10mm by 17mm by 1.8mm

Chipset NXP PN650 (PN544C3 and P5CN145 dies in a single VFBGA64 package)

System interface I2C

NFC RF standards ISO/IEC 14443 A

> ISO/IEC 14443 B ISO/IEC 15693 ISO/IEC 18092

ECMA-340 NFCIP-1 Target and Initiator

ECMA-320 NFCIP-2

NFC Forum Support Tag Type 1, Type 2, Type3 and Type 4, NFCIP-1 and NFCIP-2

Reader (PCD-VCD) Mode¹ ISO/IEC 14443 A

ISO/IEC 14443 B ISO/IEC 15693 MIFARE 1K MIFARE 4K FeliCa

ISO/IEC 14443 A

Card Emulation (PICC-VICC)

ISO/IEC 14443 B and B'

Mode¹

MIFARE FeliCa

Frequency 13.56 MHz

NFC Modes Supported Reader/Writer, Peer-to-Peer, Card Emulation

Raw RF Data Rates 106, 212, 424 kbps

Embedded Secure Element 144 KB EEPROM, Data Memory or Program Memory

> 264 KB User ROM **7.5 KB RAM**

PKI (Public Key Infrastructure) coprocessor

Dual Triple DES Key coprocessor

NFC-WI interface to NFC controller, PN544

MIFARE 4 KB card emulation

EEPROM data retention time 20 years, minimum

Operating temperature 0°C to 70°C Storage temperature -40° to 80°C **Humidity** 10-90% operating

5-95% non-operating



Technical Specifications - Communications

Supply Operating voltage 2.97 to 5.25 Volts **I/O Voltage** 1.8V or 3.3V

Power Consumption (Supply 3.3 Mode Power Consumption, Typical²

Volts) Reset 10 μW

Standby 150 μW
Card Emulation within Polling Loop 297 μW
When generating RF 120 mW

Transmitter Supply Current (Continuous wave) 30 mA

Antenna Antenna connector, 0.5mm pitch, 5 connector FPC. Antenna matching is external to module.



¹ With application or UICC support

²Actual Power Consumption is dependent on NFC antenna and matching circuit and on the particular polling sequence and period configured.

Technical Specifications - Audio

Realtek ALC3228 High Definition Audio

Type Integrated

HD Stereo Codec Realtek ALC3228 4-channel codec

Ports Line-In/Microphone input ports are 47K (nominal) at the pin

Line-Out intended to drive an external 10K load (nominal) and an on board shunt resistor of 20-47K

(nominal)

Headphone-Out designed to drive 32 ohm (nominal) headphones or a 10K (nominal) load

All ports are 3.5 mm

Internal Speaker Amplifier

2.2W/channel Class-D stereo BTL speaker amplifier@ 4 ohms and 5V

Sampling

The ALC3228 audio CODEC provides stereo 24- bit, full duplex resolution supporting sample rates up to 192kHz by the DAC and ADC. Additional sample rates are supported by the driver software.

Analog Audio Yes

of Channels on Line-Out

4 Channels (2 stereo DACs and 2 stereo ADCs) with 24-bit resolution

Internal Speaker Yes

DTS Studio Sound Technology

Introduction

DTS Studio Sound provides the ultimate audio and entertainment experience for all PC applications related to music, movies and games. Utilizing DTS' revolutionary 3D audio technology, DTS Studio Sound provides the most immersive and realistic listening experience unlike any solution ever offered for a two speaker playback environment. DTS Studio Sound offers a wider surround effect and significantly more natural positioning of audio for both 2D and 3D content and delivers immersive surround complete with deep, rich enveloping bass and crystal clear dialog. It also delivers high-frequency definition for crisp detail in any listening environment, ensuring users a premium and natural entertainment experience across any speaker configuration (desktop speakers or headphones).

DTS Studio Sound Features

- The ultimate multimedia audio experience
- Immersive surround sound from two speakers or headphones
- Extracts acoustic placement cues from original audio signal and adds near and far depth to the sound field to maximize 3D surround effect
- Custom-tuned solutions to provide superior natural sound from desktop speakers and headphones
- Maximum volume from small speakers
- Deep, rich bass and crystal clear dialog
- Intuitive user interface with presets for ease of use

DTS Studio Sound Benefits

- Provides a remarkably immersive 3D surround sound experience for business multimedia applications, complete with deep, rich enveloping bass, and crystal clear dialog
- Ability to personalize acoustic preferences with speaker and headphone optimization

Technical Specifications – Keyboards and Pointing Devices

HP USB Keyboard

Keys 104, 105, 106, 107, 109 layout (depending upon country)

Physical characteristics Dimensions (L x W x H) 18.12 x 6.47 x 0.96 in (46.03 x 16.43 x 2.44 cm)

Weight 2 lb (0.9 kg)

Operating voltage + 5VDC ± 5%

Power consumption 50-mA maximum (with three LEDs ON)

System interface USB Type A plug connector Electrical

ESD CE level 4, 15-kV air discharge

EMI - RFI Conforms to FCC rules for a Class B computing device

Microsoft® PC 99 - 2001 Functionally compliant

Keycaps Low-profile design

Switch actuation 55-g nominal peak force with tactile feedback

Switch life 20 million keystrokes (using Hasco modified tester)

Mechanical Switch type Contamination-resistant switch membrane

Key-leveling mechanisms For all double-wide and greater-length keys

Cable length 6 ft (1.8 m)

Microsoft PC 99 - 2001 Mechanically compliant

Acoustics 43-dBA maximum sound pressure level

Operating temperature 50° to 122° F (10° to 50° C)

Non-operating temperature -22° to 140° F (-30° to 60° C)

Operating humidity 10% to 90% (non-condensing at ambient)

Non-operating humidity 20% to 80% (non-condensing at ambient)

Environmental Operating shock 40 g, six surfaces

Non-operating shock 80 g, six surfaces

Operating vibration 2-g peak acceleration
Non-operating vibration 4-g peak acceleration

Drop (out of box) 26 in (66 cm) on carpet, six-drop sequence

Drop (in box) 42 in (107 cm) on concrete, 16-drop sequence

Approvals UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC

Ergonomic compliance ANSI HFS 100, ISO 9241-4, and TUVGS



Technical Specifications – Keyboards and Pointing Devices

Keyboard Installation Guide
Kit contents

Operating voltage

Warranty Card Safety and Comfort Guide

HP PS/2 Keyboard

Keys 104, 105, 106, 107, 109 layout (depending upon country)

Physical Characteristics Dimensions 18.12 x 6.47 x 0.96 in (46.03 x 16.43 x 2.44 cm)

(L x W x H)

+ 5VDC ± 5%

Weight 2 lb (0.9 kg) minimum

Power consumption 50-mA maximum (with three LEDs ON)

System interface PS/2 6-pin mini din connector **Electrical**

ESD CE level 4, 15-kV air discharge

EMI - RFI Conforms to FCC rules for a Class B computing device

Microsoft PC 99 - 2001 Functionally compliant

Keycaps Low-profile design

Switch actuation 55-g nominal peak force with tactile feedback

Switch life 20 million keystrokes (using Hasco modified tester)

Mechanical Switch type Contamination-resistant switch membrane

Key-leveling mechanisms For all double-wide and greater-length keys

Cable length 6 ft (1.8 m)

Microsoft PC 99 - 2001 Mechanically compliant

Acoustics 50-dBA maximum sound pressure level

Operating temperature 32° to 104° F (0° to 40° C)

Non-operating temperature -22° to 140° F (-30° to 60° C)

Operating humidity 15% to 80% (non-condensing at ambient)
Non-operating humidity 15% to 90% (non-condensing at ambient)

Operating shock N/A

Environmental Non-operating shock 65 inch 2.9 ms, six surface; 30g 266 inch/second; 50g 266

inch/second six surface

Operating vibration 2-g peak acceleration

Non-operating vibration Starting at 5 Hz, vary the frequency of vibration from 5 to 500 Hz

and back to 5 Hz at a Logarithmic sweep rate of 1 octave per

minute.

Drop (out of box) 26 in (66 cm) on carpet, six-drop sequence

Drop (in box) 29.93 in (76 cm) on concrete, 16-drop sequence

Approvals CUL, ICES-003 Class B, FCC, CE Mark, TUV GS, VCCI, BSMI, C-Tick, KC

Ergonomic compliance ANSI HFS 100, ISO 9241-4, and TUVGS

HP USB Smart Card (CCID) Keyboard Introduction:

Boost your security, simplify access procedures and reduce the costs associated with managing networks by preventing unauthorized access to your computers and networks using smartcard technology with the HP Smart Card (CCID) Keyboard.

The USB Smart Card (CCID) Keyboard is a full-sized keyboard that takes advantage of digital signatures and certificates to secure the environment for transactions performed on both public and private networks. The USB Smart Card (CCID) Keyboard works with all smart cards that comply with ISO standard 7816.

Smart cards are easy-to-use credit card-sized devices which require multiple forms of information to be validated before you gain access to your accounts or resources. Used worldwide, smart cards strengthen access to a network or other resource using dual-factor authentication. Implementing a two-factor authentication (or multi-factor authentication) process reduces the risk of unauthorized access by verifying and validating your identity in one of the following ways:

- Something you know a combination of username and password or PIN
- Something you have a smart card or security token.

Something you have (smart card) plus something you know (PIN), improves user-access security within corporate network environments. Smart cards are used in government agencies, healthcare companies and the finance industry.

HP ProtectTools Smart Card Manager provides authentication software for the smart card. The Smart Card Reader module works with the HP ProtectTools Security Manager and enables the user to setup, use, and manage the smart card. This allows strengthened security with HP patented technology.

- Protects against unauthorized access with smart card technology
- Delivers even greater security when combined with a HP ProtectTools smart card and the HP ProtectTools Security Software
- Combination of username and password or pin with a smart card or security token
- Secures online transactions using digital signatures and certificates
- Conforms to industry standards for ease of setup and use
- Delivers long product life and quiet operation with high-impact materials and lubricated keys
- Spill drain feature

Keys 104, 105, 106, 107, 109 layout

(depending upon country

Form factor USB basic smart card keyboard

Physical Characteristics Colors Carbonite/Silver



Key Benefits:

Electrical

Environmental

Technical Specifications – Keyboards and Pointing Devices

Dimensions 18.2 x 6.3 x 1.3 in (46.3 x 16.1 x 3.3 cm)

 $(H \times W \times D)$

Weight 2 lb (0.9 kg) minimum

+ 5VDC ± 5% Operating voltage

Power consumption 100-mA maximum (with four LEDs ON)

System interface USB Type A plug connector

ESD CE level 4, 15-kV air discharge

EMI - RFI Conforms to FCC rules for a Class B computing device

Microsoft PC 99 - 2001 Functionally compliant

Languages 30+ available Standard design Keycaps

Switch actuation 55 g nominal peak force with tactile feedback

Switch life 20 million keystrokes

(using Hasco modified tester)

Mechanical Contamination-resistant membrane Switch type

> Key-leveling mechanisms For all double-wide and greater-length keys

Cable length 6 ft (1.8 m)

Microsoft PC 99 - 2001 Mechanically compliant

Acoustics 43-dBA maximum sound pressure level

Operating temperature 50° to 122° F (10° to 50° C) -22° to 140° F (-30° to 60° C) Non-operating temperature

Operating humidity 10% to 90% (non-condensing at ambient) 20% to 80% (non-condensing at ambient) Non-operating humidity

Operating shock 40 q, six surfaces Non-operating shock 80 g, six surfaces

Operating vibration 2-g peak acceleration Non-operating vibration 4-g peak acceleration

Drop (out of box)

26 in (66 cm) on carpet, six-drop sequence

Drop (in box) 42 in (107 cm) on concrete, 16-drop sequence

All ISO 7816 smart cards Support

Interface Reads from and writes to all ISO7816-1, 2, 3, 4 memory and

microprocessor smart cards (T=0, T=1)

Chipset **SCM STCIII**

Standard APIs supported PC/SC, EMV2000, CT-API

Power **USB Port**

> Short circuit detection (protects smart card and reader) Power supply compliant with ISO7816 and EMV (5V, 60 mA)

Supports 3-V and 5-V cards

Power consumption 100-mA maximum draw



SmartCard Function

Communication From card 9600 bps to 330,000 bps

From computer 12 Mbps (USB transfer speed)

Landing mechanism Contact device Friction contact

Card insertions rating Up to 100,000 insertion cycles

Interface modes CCID protocol

Reader performance interface USB connection

Electro-magnetic standards Europe 2004/108/EC

USA USAFCC part 15

Approvals CE-Mark, UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC, EMV2000, USB-IF

Ergonomic Compliance ISO 9241-4, TUVGS

Kit Contents Keyboard, I/O Security and Documentation CD, warranty card

HP USB PS/2 Washable Keyboard

Keys 104 (US) Layout, 105 (EU) layout - depending upon country

Physical CharacteristicsDimensions 17.67x 6.62 x 1.38 in (449 x 168 x 35 mm)

 $(L \times W \times H)$

Weight 1.7 lb (0.77 kg) minimum

Operating voltage + 5VDC ±5%

Power consumption 50-mA maximum (with three LEDs ON)

System interface USB Type A plug connector Electrical

ESD CE level 4, 15-kV air discharge

EMI - RFI Conforms to FCC rules for a Class B computing device

Microsoft® PC 99 - 2001 Functionally compliant

Keycaps Stepped -profile design

Switch actuation 55-g nominal peak force with tactile feedback

Switch life 20 million keystrokes

Switch type Contamination-resistant switch membrane Mechanical

Key-leveling mechanisms For all double-wide and greater-length keys

Cable length 7 ft (2.2 m)

Microsoft PC 99 - 2001 Mechanically compliant

Acoustics 43-dBA maximum sound pressure level

Operating temperature 50° to 122° F (10° to 50° C)

Non-operating temperature 4° to 149° F (-20° to 65° C)

Operating humidity 10% to 95% (non-condensing at ambient)

Non-operating humidity 0% to 95% (non-condensing at ambient)

Operating shock 40 g, six surfaces **Environmental**

Non-operating shock 80 g, six surfaces

Operating vibration 2-g peak acceleration

Non-operating vibration 4-g peak acceleration

Drop (out of box) 26 in (66 cm) on carpet, six-drop sequence

Drop (in box) 42 in (107 cm) on concrete, 16-drop sequence

Operating system support Windows® 7, Windows Vista, Windows XP Professional

Approvals UL, cUL, FCC, CE, TUV GS, VCCI, BSMI, C-Tick, KCC, USB-IF, WHQL, EN/IEC 60601-1, IP66/NEMA4X

Ergonomic compliance ANSI HFS 100, ISO 9241-4, and TUVGS

HP Wireless Keyboard and Mouse

Dimensions (H x L x W) 1.09 x 18.1 x 6.47 in (27.87 x 460.3 x 164.3 mm

Keyboard Weight – Without Two AA 1.94 lb (880 g)

Alkaline Batteries

Dimensions (H x L x W) 1.46 x 4.53 x 2.47 in (37 x 115 x 62.9 mm)

0.15 lb (67 g)

Mouse Waisha Without Toron AA 0.15 lb (67.5)

Weight – Without Two AA

Alkaline Batteries

Dimensions (H x L x W) 0.33x 1.79 x 0.72 in (8.4 x 45.5 x 18.4 mm)

Weight 0.21 oz (5.9 g)

Cable Length – Minimum 6 ft (1.8 m)

Range 32.8 ft (10 m)

Windows 7 Home Basic*, Windows 7 Home Premium*, Windows 7 Professional Edition 32*, Windows 7 Professional Edition 64*, Windows 7 Ultimate Edition 32*, Windows 7 Ultimate Edition

64* Windows Vista or Windows XP Available USB port for the receiver

CD-ROM Drive

*This system may require upgraded and/or separately purchased hardware and/or a DVD drive to install the Windows 7 software and take full advantage of Windows 7 functionality. See http://www.microsoft.com/windows/windows-7/ for details.

Product Safety

UL; CSA /TUV (Europe only); CE Mark; CB Report

Ergonomics

ANSI; ISO (Europe only); GS Mark (Germany only)

EMC FCC; CE; ACA (-tick); BSMI; KC; VCCI

CE Mark EN 55022:2010; EN 55024; EN 301489-1; EN 61000



Receiver

System Requirements Design Guidelines for PCs PC 99 - connector overmold colors; PC 2001 - full functionality

Telecom All local telecom requirements and approvals for intended

markets

USA FCC Title 47 CFR, Par 15, Subpart C; other local requirements

Country Support US, Belgium, Switzerland, Spain, Denmark, Netherlands, France,

Germany, Italy, Portugal, Sweden, Norway, Finland, UK, Poland, Czech Republic, Turkey, Greece, Austria, Bulgaria, Cyprus, Estonia, Hungary, Ireland, Latvia, Lithuania, Luxemburg, Malta, Romania, Slovakia, Slovenia, Vietnam, HK, Australia, NZ, Malaysia, Singapore, Indonesia, Philippines, Thailand, Canada, China, Japan, Korea, Taiwan, India, Venezuela, Ecuador, Russia, Ukraine, Israel, Croatia, United Arab Emirates, Peru, Brazil, Chile,

80 cm height onto asphalt tile over concrete or equivalent, 5-drop

Argentina, Mexico, South Africa, and up to 193 countries

worldwide.

Environmental Keyboard contains 25% post-consumer recycled plastic material.

HP PS/2 Mouse

Dimensions 1.46 x 2.48 x 4.53 in (3.70 x 6.29 x 11.50 cm)

Drop

 $(H \times L \times W)$

Weight 3.53 oz (100g; +10g/- 5 g)

Operating temperature -32° to 104°F (0° to 40° C)

Non-operating temperature -4° to 140°F (-20° to 60° C)

Operating humidity 10% to 90%

(non condensing at ambient)

Non-operating humidity 10% to 90%

(non condensing at ambient)

Environmental Operating shock

Operating shock 40 g, 6 surfaces

Non-operating shock 80 g, 6 surfaces

Operating vibration 2 g peak acceleration

Non-operating vibration 4 g peak acceleration

(out of box) in 5 direction except the cable face

Operating voltage 5 VDC ± 10%

Power consumption 100mA

System consumption PS/2 mini-din connector

ESD CE level 4, 15 kV air discharge

Electrical

Technical Specifications – Keyboards and Pointing Devices

EMI-RFI Conforms to FCC rules for a Class B computing device

Microsoft PC99 - 2001 Functionally compliant

Resolution 800 DPI

Tracking speed 10 in/s (25.4 cm/s) maximum

Acceleration ±15%

Switch actuation 65±20 gf

Mechanical Switch life 3,000,000 operations (using Hasco modified tester)

Switch type Low force micro-switches

Tracking mechanism life 80 km

Cable length 6 ft (1.8 m)

Microsoft PC99 - 2001 Mechanically compliant

Width 6 mm

Diameter $22.5 \pm 0.2 \text{ mm}$

Maximum rotation force 50 gf-cm Scroll wheel

Switch type Light force micro-switch

Switch life 1 million operations

Mechanical life Minimum 200,000 revolutions

Regulatory Approvals UL/cUL, FCC, CE Mark, TUV/GS, VCCI, KCC, BSMI, C-Tick

HP USB Optical Mouse

Dimensions (H x L x W) 1.5x 4.5 x 2.5 in (3. 7x 11.5 x 6.3 cm)

Weight 0.22 lb (0.10 kg)

Cable length 70.9 in (180 cm)

System requirements Available USB port



Technical Specifications – Keyboards and Pointing Devices

HP USB 1000dpi Laser Mouse

Dimensions 1.47 x 4.53 x 2.47 in (37.3 x 114.97 x 62.86 mm)

(HxLxW)

Weight 3.360 oz (102g)

Cable length 70.9 in (180 cm)

System requirements Available USB port

Environmental Operating Temperature 32° to 104° F (0° to 40° C)

Non-operating Temperature -4° to 140° F (-20° to 60° C)

Operating Humidity 10% to 90%

(non-condensing at ambient)

Mechanical Resolution 1000dpi

Tracking Speed 45 cm/sec

Cable Length 70.9 in (180 cm)

HP USB PS/2 Washable Mouse

Dimensions (H x L x W) 1.56 x 2.44 x 4.61 in (3.95 x 6.21 x 11.7 cm)

Weight 4.44 oz (126 g)

Environmental Operating temperature -32° to 104°F (0° to 40° C)

Non-operating –4° to 140°F (–20° to 60° C)

temperature

Operating humidity 10% to 90% (non-condensing at ambient) Non-operating humidity 10% to 90% (non condensing at ambient)

Operating shock 40 g, 6 surfaces
Non-operating shock 80 g, 6 surfaces
Operating vibration 2 g peak acceleration
Non-operating vibration 4 g peak acceleration

Drop (out of box) 80 cm height onto asphalt tile over concrete or equivalent, 5-drop in 5

direction except the cable face

Electrical Operating voltage 5 VDC ± 10%

Power consumption 100mA

System consumption PS/2 mini-din connector ESD CE level 4, 15 kV air discharge

EMI-RFI Conforms to FCC rules for a Class B computing device

Microsoft® PC99 – 2001 Functionally compliant

Mechanical Resolution 400 ± 20% DPI

Tracking speed 10 in/s (25.4 cm/s) maximum Acceleration 100 in/s/s (2.54 m/s/s)



Switch actuation 61 g nominal peak force

Switch life 3,000,000 operations (using Hasco modified tester)

Switch type Low force micro-switches

Tracking mechanism life 155 mi (250 km) at average speed of 10 in/s

Cable length 6 ft (1.8 m)

Microsoft PC99 – 2001 Mechanically compliant

Scroll wheel Width 8 mm

Diameter 1.01 in (25.6 mm)

Maximum rotation speed 48 rats/sec

Switch type Light force micro-switch
Switch life 1 million operations

Mechanical life Minimum 200,000 revolutions

Regulatory approvals Compliant UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC

Compatibility Operating system support Windows 7, Windows Vista Business 64*, Windows Vista Business 32*,

Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32* (No driver is required for this device. Native support is

provided by the operating system.), xpe, ce.net, Linux, XP-64

* Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: http://www.windowsvista.com/upgradeadvisor. For Windows Vista

system requirements, visit:

http://www.windowsvista.com/systemrequirements.



Technical Specifications - Environmental Data

Eco-Label Certifications & This product has received or is in the process of being certified to the following approvals and may be declarations labeled with one or more of these marks:

- US ENERGY STAR®
- EPEAT® Gold registered in the United States. See http://www.epeat.net for registration status in your country
- IT ECO declaration

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the All-in-One PC model is based on a typically configured product

Energy Consumption	115 VAC	230 VAC	100 VAC
Normal Operation	21.64 W	22.10 W	21.01 W
Sleep (ENERGY STAR® low power mode)	1.70 W	1.78 W	1.69 W
Off	1.26 W	1.24 W	1.28 W

NOTE: Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family . HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured model.

Н	ea	+ 1	Ni	cc	in	a	ti	n	n
ш	ca	u	וע	33	ιμ	a	u	u	ш

115 VAC	230 VAC	100 VAC
74 BTU/hr	76 BTU/hr	72 BTU/hr
6 BTU/hr	6 BTU/hr	6 BTU/hr
4 BTU/hr	4 BTU/hr	4 BTU/hr

NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)

Sound Power (LWAd, bels)	Sound Pressure (LpAm, decibels)
3.4	22
3.4	22

Longevity and Upgrading

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

- 6 USB 3.0 ports
- · 2 memory slots
- 1 Mini PCIe half-length slot
- 1 MXM 3.0 Type A 35W slot
- 1 mSATA slot
- 1 2.5" internal bay supporting up to Two 2.5" hard drives (HDD/SSD/SED/SSHD)
- 1 5.25" external supporting optical drive

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

Batteries

This battery(s) in this product comply with EU Directive 2006/66/EC



Technical Specifications - Environmental Data

Batteries used in the product do not contain: Mercury greater the1ppm by weight Cadmium greater than 20ppm by weight

Battery size: CR2032 (coin cell)

Battery type: Lithium

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive -2002/95/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE)
 Directive 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold where HP registers commercial desktop products. See http://www.epeat.net for registration status in your country.
- Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
- This product contains 36.9% post-consumer recycled plastic (by wt.)
- This product is 97.6% recyclable when properly disposed of at end of life.

Packaging Materials

- External:
 - O PAPER/Corrugated 1516 g
 - O PAPER/Paper 94 g
- Internal:
 - O PLASTIC/EPE Expanded Polyethylene 533 g
 - O PLASTIC/Polyethylene high density 39 g
 - The PAPER/Cardboard packing material is made from 100% recycled content.
 - The PAPER/PAPER packing material is made from 100% recycled content.
 - The PLASTIC/EPE- Expanded Polyethylene packing material contains at least 5% recycled content.
 - The PLASTIC/Polyethylene high density packing material contains at least 5% recycled content.

RoHS Compliance

Hewlett-Packard is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis. By July 1, 2006, RoHS substances will be virtually eliminated (virtually = to levels below legal limits) for all HP electronic products subject to the RoHS Directive, except where it is widely recognized that there is no technically feasible alternative (as indicated by an exemption under the EU RoHS Directive).

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at:

http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries



Technical Specifications – Environmental Data

- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and Recycling

Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

Hewlett-Packard Corporate Environmental Information

For more information about HP's commitment to the environment:

Global Citizenship Report

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Eco-label certifications

http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html

ISO 14001 certificates:

http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html



Options and Accessories (sold separately)

ΔF	ΓFR	МΔ	RKET	NPT	IUNC.
$\mathbf{A}\mathbf{\Gamma}$	LR	1416		UFI	IVII J.

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ADDITIONAL MONITORS FOR MULTI-DISPLAY CONFIGURATIONS	Part Number
HP EliteDisplay E190i 18.9-inch LED Backlit Monitor	E4U30AA
HP EliteDisplay E201 20-inch LED Backlit Monitor	C9V73AA
HP EliteDisplay E221 21.5-inch LED Backlit Monitor	C9V76AA
HP EliteDisplay E221c 21.5-inch Webcam LED Backlit Monitor	D9E49AA
HP EliteDisplay E231 23-inch LED Backlit Monitor	C9V75AA
HP EliteDisplay E241i 24-inch LED Backlit Monitor	FOW81AA
HP EliteDisplay E271i 27-inch LED Backlit Monitor	D7Z72AA
HP L2206tm 21.5-inch LED Backlit Touchscreen Monitor	BOL55AA
HP EliteDisplay S230tm 23-inch Touch Monitor	E4S03AA
MEMORY	Part Number
HP 2GB DDR3-1600 (PC3-12800) SODIMM	B4U38AA
HP 4GB DDR3-1600 (PC3-12800) SODIMM	B4U39AA
HP 8GB DDR3-1600 (PC3-12800) SODIMM	B4U40AA
DATA STORAGE DRIVES AND ACCESSORIES	Part Number
HP 500GB SATA , 6G (8GB cache) Solid State Hybrid Drive (SSHD)	E1C62AA
HP 128GB SATA Solid State Drive	QV063AA
HP 160GB SATA Solid State Drive	QV064AA
HP Slim SATA DVD-ROM Drive	VP033AA
HP Slim SATA BDXL Blu-Ray Writer Drive	EOX94AA
HP Slim SATA SuperMulti DVD Writer Drive	QS209AA
INPUT DEVICES - KEYBOARD AND MOUSE COMBO	Part Number
HP USB PS/2 Washable Keyboard & Mouse	BU207AA
HP Wireless Keyboard & Mouse (Keyboard contains 25% post-consumer recycled plastic material)	QY449AA
INPUT DEVICES - KEYBOARD	Part Number
HP PS/2 Keyboard	QY774AA

INPUT DEVICES - MOUSE

HP USB Keyboard

Part Number QY775AA

HP PS/2 Mouse HP USB 1000dpi Laser Mouse

HP USB Smart Card (CCID) Keyboard

QY778AA

E6D77AA

QY776AA



Options and Accessories (sold separately)

HP USB Mouse QY777AA
HP Mouse Pad AT485AA

SECURITY Part Number

HP UltraSlim Cable Lock H4D73AA

HP DisplayPort Cable Kit

HP DisplayPort To DVI-D Adapter

HP DisplayPort To HDMI Adapter

HP DisplayPort To VGA Adapter

HP DVI Cable

USB Graphics Adapter

NL571AA

STANDS AND MONITOR ARMPart NumberAiO Height Adjustable and Reclining StandC1N43AAHP Single Monitor ArmBT861AAHP (Flat Panel Monitor) Quick ReleaseEM870AA

MISCELLANEOUSPart NumberBelkin 7-Outlet Surge Protector for North America 120VAG290AABelkin USB to Serial AdapterEM449AABelkin CAT5e Patch Cable RJ45/RJ45AH122AA

HP Business Headset QK550AA

LANDESK SOFTWARE (E-DELIVERY) Part Number

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N/A